## Octal Bidirectional Transceivers with 3-state Outputs

# **HITACHI**

ADE-205-111B(Z) 3rd Edition December 1996

### Description

The HD74LVC245A has eight buffers with three state outputs in a 20 pin package. When  $(T / \overline{R})$  is high, data flows from the A inputs to the B outputs, and when  $(T / \overline{R})$  is low, data flows from the B inputs to the A outputs. A and B bus are separated by making enable input  $(\overline{OE})$  high level. Low voltage and high speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

#### **Features**

- $V_{CC} = 2.0 \text{ V to } 5.5 \text{ V}$
- All inputs  $V_{IH}$  (Max.) = 5.5 V (@ $V_{CC}$  = 0 V to 5.5 V)
- All input outputs  $V_{I/O}$  (Max.) = 5.5 V (@ $V_{CC}$  = 0 V or output off state)
- Typical  $V_{OL}$  ground bounce < 0.8 V (@ $V_{CC}$  = 3.3 V, Ta = 25°C)
- Typical  $V_{OH}$  undershoot > 2.0 V (@ $V_{CC}$  = 3.3 V, Ta = 25°C)
- High output current  $\pm 24$  mA (@V<sub>CC</sub> = 3.0 V to 5.5 V)

#### **Function Table**

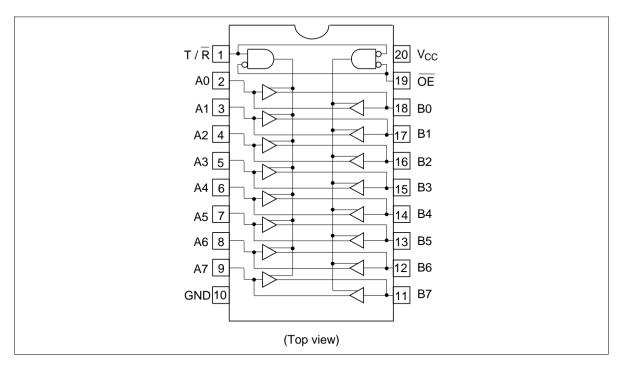
#### Inputs

OE	T/R	Operation		
L	L	B data to A bus		
L	Н	A data to B bus		
Н	Χ	Z		

H: High levelL: Low levelX: ImmaterialZ: High impedance



### **Pin Arrangement**



### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>cc</sub>	-0.5 to 6.0	V	
Input diode current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> = -0.5 V
Input voltage	V <sub>I</sub>	-0.5 to 6.0	V	T / R, OE
Output diode current	I <sub>OK</sub>	-50	mA	V <sub>o</sub> = -0.5 V
		50	mA	$V_0 = V_{CC} + 0.5 \text{ V}$
Input / output voltage	V <sub>I/O</sub>	-0.5 to V <sub>cc</sub> +0.5	V	Output "H" or "L"
		-0.5 to 6.0	V	Output "Z" or V <sub>cc</sub> :OFF
Output current	Io	±50	mA	
V <sub>cc</sub> , GND current / pin	I <sub>CC</sub> or I <sub>GND</sub>	100	mA	
Storage temperature	Tstg	-65 to 150	°C	

Note: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

### **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>cc</sub>	1.5 to 5.5	V	Data retention
		2.0 to 5.5	V	At operation
Input / output voltage	Vı	0 to 5.5	V	T / R, OE
	V <sub>I/O</sub>	0 to V <sub>cc</sub>	V	Output "H" or "L"
		0 to 5.5	V	Output "Z" or V <sub>cc</sub> :OFF
Operating temperature	Та	-40 to 85	°C	
Output current	I <sub>OH</sub>	-12	mA	$V_{CC} = 2.7 \text{ V}$
		-24 <sup>*2</sup>	mA	V <sub>cc</sub> = 3.0 V to 5.5 V
	I <sub>OL</sub>	12	mA	V <sub>CC</sub> = 2.7 V
		24*2	mA	V <sub>cc</sub> = 3.0 V to 5.5 V
Input rise / fall time *1	t <sub>r</sub> , t <sub>f</sub>	10	ns/V	

Notes: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

2. duty cycle ≤ 50%

### **Electrical Characteristics**

Ta	_ 40	٠.	85°C	
14	= -41	1 10	00.0	

Item	Symbol	V <sub>cc</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	$V_{\text{IH}}$	2.7 to 3.6	2.0	_	V	
		4.5 to 5.5	$V_{cc}\!\! imes\!0.7$	_	V	_
	V <sub>IL</sub>	2.7 to 3.6	_	0.8	V	
		4.5 to 5.5	_	V <sub>cc</sub> ×0.3	V	_
Output voltage	V <sub>OH</sub>	2.7 to 5.5	V <sub>CC</sub> -0.2	_	V	$I_{OH} = -100 \mu A$
		2.7	2.2	_	V	I <sub>OH</sub> = -12 mA
		3.0	2.4	_	V	_
		3.0	2.2	_	V	I <sub>OH</sub> = -24 mA
		4.5	3.8	_	V	_
	V <sub>OL</sub>	2.7 to 5.5	_	0.2	V	I <sub>OL</sub> = 100 μA
		2.7	_	0.4	V	I <sub>OL</sub> = 12 mA
		3.0	_	0.55	V	I <sub>OL</sub> = 24 mA
		4.5	_	0.55	V	_
Input current	I <sub>IN</sub>	0 to 5.5	_	±5.0	μΑ	V <sub>IN</sub> = 5.5 V or GND
Off state output current	I <sub>oz</sub>	2.7 to 5.5	_	±5.0	μΑ	V <sub>IN</sub> = V <sub>CC</sub> , GND
						$V_{OUT} = 5.5 \text{ V or GND}$
Output leak current	I <sub>OFF</sub>	0	_	20	μΑ	$V_{IN} / V_{OUT} = 5.5 V$
Quiescent supply current	I <sub>cc</sub>	2.7 to 3.6	_	±10	μΑ	$V_{IN} / V_{OUT} = 3.6 \text{ to } 5.5 \text{ V}$
		2.7 to 5.5	_	10	μΑ	$V_{IN} = V_{OUT}$ or GND
	$\Delta I_{CC}$	3.0 to 3.6	_	500	μΑ	$V_{IN}$ = one input at $(V_{CC} - 0.6)V$ , other inputs at $V_{CC}$ or GND

### **Switching Characteristics**

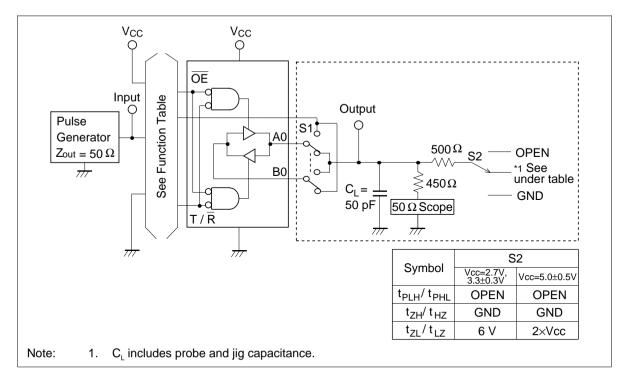
Ta = -40 to 85°C

Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	_ Unit	From (Input)	To (Output)
Propagation delay time	t <sub>PLH</sub>	2.7	_	_	8.0	ns	A or B	B or A
	t <sub>PHL</sub>	3.3±0.3	1.5	_	7.0	ns	=	
		5.0±0.5	_	_	5.5	ns	=	
Output enable time	t <sub>zH</sub>	2.7	_	_	9.5	ns	ŌĒ	A or B
	$t_{zL}$	3.3±0.3	1.5	_	8.5	ns	=	
		5.0±0.5	_	_	7.0	ns	=	
Output disable time	t <sub>zH</sub>	2.7	_	_	8.5	ns	ŌĒ	A or B
	$\mathbf{t}_{LZ}$	3.3±0.3	1.5	_	7.5	ns	_	
		5.0±0.5	_	_	6.5	ns	_	
Between outut pins skew *1	t <sub>OSLH</sub>	2.7	_	_	_	ns		
	$t_{\text{OSHL}}$	3.3±0.3	_	_	1.0	ns	_	
		5.0±0.5	_	_	1.0	ns	_	
Input capacitance	C <sub>IN</sub>	2.7	_	3.0	_	pF		
Output capacitance	Co	2.7	_	15.0	_	pF		

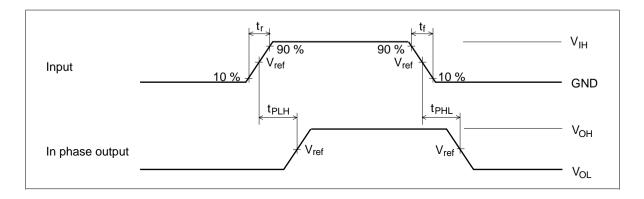
Note: 1. This parameter is characterized but not tested.

 $\mathsf{tos}_\mathsf{LH} = |\ t_\mathsf{PLHm} \text{--} \ t_\mathsf{PLHn}|,\ \mathsf{tos}_\mathsf{HL} = |\ t_\mathsf{PHLm} \text{--} \ t_\mathsf{PHLn}|$ 

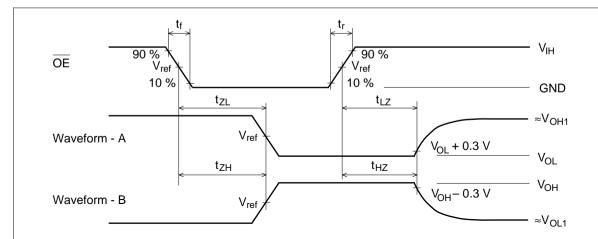
### **Test Circuit**



### Waveforms - 1



### Waveforms – 2

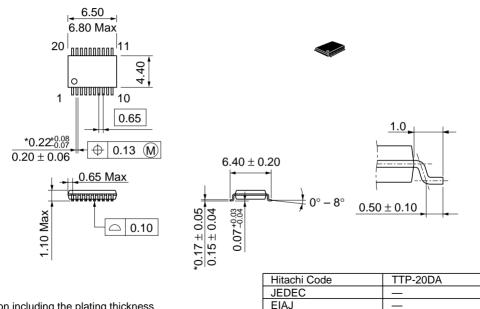


TEST	Vcc=2.7V, 3.3±0.3V	Vcc=5.0±0.5V
$V_{IH}$	2.7 V	Vcc
$V_{ref}$	1.5 V	50%Vcc
V <sub>OH1</sub>	3 V	Vcc
V <sub>OL1</sub>	GND	GND

Notes:

- 1.  $t_r = 2.5 \text{ ns}, t_f = 2.5 \text{ ns}$
- 2. Input waveform: PRR = 10 MHz, duty cycle 50%
- 3. Waveform A shows input conditions such that the output is "L" level when enable by the output control.
- 4. Waveform B shows input conditions such that the output is "H" level when enable by the output control.

Unit: mm



Weight (reference value)

0.07 g

\*Dimension including the plating thickness
Base material dimension

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